Sir:

Transmitted herewith for filing is the Patent Application of: XIAN BIN WANG

A NEW DESIGN AND METHOD OF FABRICATION OF A DIE OXIDE RING

9							
Enclosed are:							
x	4 sheets of drawing(s) - formal.						
X	An assignment of the invention to Chartered Semiconductor Manufacturing Ltd.						
	An associate power of attorney Applicant claims small entity status						
	Request & Certification under 35 USC 122(b)(2)(b)(i)						
The filing fee has been calculated as shown below:							
		(Col. 1)	(Col. 2)	OTHER THAN	A SMALL ENTITY		
FOR:		NO. FILED	NO. EXTRA	RATE	FEE		
BASIC FEE		><	><		\$ 770.		
TOTAL CLAIMS		9 -20=	0	x 18 =	\$ 0.		
INDEP CLAIMS		3 -3=	0	x 86 =	\$ 0.		
				UB TOTAL	\$ 770.		
			A	SSIGNMENT	\$40.		
			LT	OTAL	\$ 810.		
X	Please charge my Deposit Account No. 19-0033 in the amount of \$810. A duplicate copy of this sheet is enclosed.						
X	The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any						
	overnavment	verpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.					

IEN B. ACKERMAN, REG. NO. 37,761

EXPRESS MAIL CERTIFICATE

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Signature / Date

Any additional filing fees required under 37 CFR §1.16.

Any patent application processing fees under 37 CFR §1.17.